# MOC3031M, MOC3032M, MOC3033M, MOC3041M, MOC3042M, MOC3043M <br> 6-Pin DIP Zero-Cross Optoisolators Triac Driver Output (250/400 Volt Peak) 

Features
■ Simplifies logic control of 115 VAC power
■ Zero voltage crossing
■ dv/dt of $2000 \mathrm{~V} / \mu \mathrm{s}$ typical, $1000 \mathrm{~V} / \mu \mathrm{s}$ guaranteed
■ VDE recognized (File \# 94766), ordering option V (e.g., MOC3043VM)

Applications

| $\square$ Solenoid/valve controls | $\square$ Lighting controls |
| :--- | :--- |
| $\square$ Static power switches | $\square$ AC motor drives |
| $\square$ Temperature controls | $\square$ E.M. contactors |
| $\square$ AC motor starters | $\square$ Solid state relays |

## Description

The MOC303XM and MOC304XM devices consist of a AIGaAs infrared emitting diode optically coupled to a monolithic silicon detector performing the function of a zero voltage crossing bilateral triac driver.

They are designed for use with a triac in the interface of logic systems to equipment powered from 115 VAC lines, such as teletypewriters, CRTs, solid-state relays, industrial controls, printers, motors, solenoids and consumer appliances, etc.


Schematic


Absolute Maximum Ratings $\left(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| Parameters | Symbol | Device | Value | Units |
| :---: | :---: | :---: | :---: | :---: |
| TOTAL DEVICE |  |  |  |  |
| Storage Temperature | $\mathrm{T}_{\text {STG }}$ | All | -40 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature | T ${ }_{\text {OPR }}$ | All | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Lead Solder Temperature | $\mathrm{T}_{\text {SOL }}$ | All | 260 for 10 sec | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature Range | $\mathrm{T}_{J}$ | All | -40 to +100 | ${ }^{\circ} \mathrm{C}$ |
| Isolation Surge Voltage ${ }^{(1)}$ (peak AC voltage, $60 \mathrm{~Hz}, 1 \mathrm{sec}$ duration) | $\mathrm{V}_{\text {ISO }}$ | All | 7500 | $\operatorname{Vac}(\mathrm{pk})$ |
| Total Device Power Dissipation @ $25^{\circ} \mathrm{C}$ Derate above $25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | All | 250 | mW |
|  |  |  | 2.94 | $\mathrm{mW} /{ }^{\circ} \mathrm{C}$ |
| EMITTER |  |  |  |  |
| Continuous Forward Current | $\mathrm{I}_{\mathrm{F}}$ | All | 60 | mA |
| Reverse Voltage | $\mathrm{V}_{\mathrm{R}}$ | All | 6 | V |
| Total Power Dissipation $25^{\circ} \mathrm{C}$ Ambient Derate above $25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | All | 120 | mW |
|  |  |  | 1.41 | $\mathrm{mW} /{ }^{\circ} \mathrm{C}$ |
| DETECTOR |  |  |  |  |
| Off-State Output Terminal Voltage | $\mathrm{V}_{\text {DRM }}$ | MOC3031M/2M/3M | 250 | V |
|  |  | MOC3041M/2M/3M | 400 |  |
| Peak Repetitive Surge Current (PW = $100 \mu \mathrm{~s}, 120 \mathrm{pps}$ ) | $\mathrm{I}_{\text {TSM }}$ | All | 1 | A |
| Total Power Dissipation @ $25^{\circ} \mathrm{C}$ Ambient Derate above $25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | All | 150 | mW |
|  |  | All | 1.76 | $\mathrm{mW} /{ }^{\circ} \mathrm{C}$ |

Note

1. Isolation surge voltage, $\mathrm{V}_{\text {ISO }}$, is an internal device dielectric breakdown rating. For this test, Pins 1 and 2 are common, and Pins 4,5 and 6 are common.

Electrical Characteristics ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ Unless otherwise specified)
Individual Component Characteristics

| Parameters | Test Conditions | Symbol | Device | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| EMITTER |  |  |  |  |  |  |  |
| Input Forward Voltage | $\mathrm{I}_{\mathrm{F}}=30 \mathrm{~mA}$ | $\mathrm{V}_{\mathrm{F}}$ | All |  | 1.25 | 1.5 | V |
| Reverse Leakage Current | $\mathrm{V}_{\mathrm{R}}=6 \mathrm{~V}$ | $\mathrm{I}_{\mathrm{R}}$ | All |  | 0.01 | 100 | $\mu \mathrm{A}$ |
| DETECTOR |  |  |  |  |  |  |  |
| Peak Blocking Current, Either Direction | Rated $\mathrm{V}_{\text {DRM }}, \mathrm{I}_{\mathrm{F}}=0$ (note 1) | $\mathrm{I}_{\text {DRM1 }}$ | All |  |  | 100 | nA |
| Peak On-State Voltage, Either Direction | $\mathrm{I}_{\text {TM }}=100 \mathrm{~mA}$ peak, $\mathrm{I}_{\mathrm{F}}=0$ | $\mathrm{V}_{\text {TM }}$ | All |  | 1.8 | 3 | V |
| Critical Rate of Rise of Off-State Voltage | $\mathrm{I}_{\mathrm{F}}=0$ (Figure 9, note 3) | dv/dt | All | 1000 |  |  | V/ $/ \mathrm{s}$ |

Transfer Characteristics ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ Unless otherwise specified.)

| DC Characteristics | Test Conditions | Symbol | Device | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LED Trigger Current | $\begin{aligned} & \text { Main terminal voltage = 3V } \\ & \text { (note 2) } \end{aligned}$ | $\mathrm{I}_{\mathrm{FT}}$ | $\begin{aligned} & \text { MOC3031M/ } \\ & \text { МOC3041M } \end{aligned}$ |  |  | 15 | mA |
|  |  |  | $\begin{aligned} & \text { MOC3032M/ } \\ & \text { МОС3042M } \end{aligned}$ |  |  | 10 |  |
|  |  |  | $\begin{aligned} & \text { MOC3033M/ } \\ & \text { МОС3043M } \end{aligned}$ |  |  | 5 |  |
| Holding Current, Either Direction |  | $\mathrm{I}_{\mathrm{H}}$ | All |  | 400 |  | $\mu \mathrm{A}$ |

Zero Crossing Characteristics ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ Unless otherwise specified.)

| Characteristics | Test Conditions | Symbol | Device | Min | Typ | Max | Units |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Inhibit Voltage | $\mathrm{I}_{\mathrm{F}}=$ rated $\mathrm{I}_{\mathrm{FT}}$, MT1-MT2 voltage <br> above which device will not trigger <br> off-state | $\mathrm{V}_{\mathrm{IH}}$ | All |  |  | 20 | V |
| Leakage in Inhibited State | $\mathrm{I}_{\mathrm{F}}=$ rated $\mathrm{I}_{\mathrm{F}}$, rated $\mathrm{V}_{\text {DRM }}$, off-state | $\mathrm{I}_{\text {DRM } 2}$ | All |  |  | 500 | $\mu \mathrm{~A}$ |

## Note

1. Test voltage must be applied within dv/dt rating
2. All devices are guaranteed to trigger at an $I_{F}$ value less than or equal to max $I_{F T}$. Therefore, recommended operating $I_{F}$ lies between max $I_{F T}$ ( 15 mA for MOC3031M \& MOC3041M, 10 mA for MOC3032M \& MOC3042M, 5 mA for MOC3033M \& MOC3043M) and absolute max $\mathrm{I}_{\mathrm{F}}(60 \mathrm{~mA}$ ).
3. This is static $\mathrm{dv} / \mathrm{dt}$. See Figure 9 for test circuit. Commutating $\mathrm{dv} / \mathrm{dt}$ is a function of the load-driving thyristor(s) only.


4. The mercury wetted relay provides a high speed repeated pulse


Typical circuit (Fig 12, 13) for use when hot line switching is required. In this circuit the "hot" side of the line is switched and the load connected to the cold or neutral side. The load may be connected to either the neutral or hot line.
$R_{\text {in }}$ is calculated so that $I_{F}$ is equal to the rated $I_{F T}$ of the part, 5 mA for the MOC3033M and MOC3043M, 10 mA for the MOC3032M and MOC3042M, or 15 mA for the MOC3031M and MOC3041M. The 39 ohm resistor and $0.01 \mu \mathrm{~F}$ capacitor are for snubbing of the triac and may or may not be necessary depending upon the particular triac and load used.



Suggested method of firing two, back-to-back SCR's with a Fairchild triac driver. Diodes can be 1N4001; resistors, R1 and R2, are optional 1 k ohm.


Suggested method of firing two, back-to-back SCR's with a Fairchild triac driver. Diodes can be 1N4001; resistors, R1 and R2, are optional 330 ohm.
Note: This optoisolator should not be used to drive a load directly. It is intended to be a trigger device only.


Package Dimensions (Surface Mount)

Package Dimensions (0.4"Lead Spacing)


NOTE
All dimensions are in inches (millimeters)


Ordering Information

| Option | Order Entry Identifier | Description |
| :---: | :---: | :--- |
| S | S | Surface Mount Lead Bend |
| SR2 | SR2 | Surface Mount; Tape and reel |
| T | T | $0.4 "$ Lead Spacing |
| V | V | VDE 0884 |
| TV | TV | VDE 0884, 0.4" Lead Spacing |
| SV | SV | VDE 0884, Surface Mount |
| SR2V | SR2V | VDE 0884, Surface Mount, Tape \& Reel |



## NOTE

All dimensions are in inches (millimeters)

## Marking Information



| Definitions |  |
| :---: | :--- |
| 1 | Fairchild logo |
| 2 | Device number |
| 3 | VDE mark (Note: Only appears on parts ordered with VDE <br> option - See order entry table) |
| 4 | One digit year code, e.g., '3' |
| 5 | Two digit work week ranging from '01' to '53' |
| 6 | Assembly package code |

*Note - Parts that do not have the 'V' option (see definition 3 above) that are marked with date code ' 325 ' or earlier are marked in portrait format.

Reflow Profile (White Package, -M Suffix)


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| :---: | :---: | :---: | :---: | :---: |
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